

Combined Form PTO/SB/08A&B <u>INFORMATION DISCLOSURE STATEMENT BY APPLICANT</u> <i>(use as many sheets as necessary)</i>				<i>Complete if Known</i>	
				Application Number	Not yet assigned
				Confirmation Number	107568075
				Filing Date	February 13, 2006
				First Named Inventor	Masaharu YAMAMOTO et al.
				Art Unit	2818
Examiner Name	Jonathan Han				
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Sheet	1	of	1		

U.S. PATENT DOCUMENTS

Examiner Initials*	Cite No. ¹	Document Number		Publication Date MM-DD-YYYY	Name of Patentee or Applicant of Cited Document
		Number	Kind Code ² (if known)		
	1	US 2004/0023487	A1	2/5/2004	Shiomi et al.
		US			
		US			
		US			
		US			
		US			

FOREIGN PATENT DOCUMENTS

Examiner Initials*	Cite No. ¹	Foreign Patent Document			Publication Date MM-DD-YYYY	Name of Patentee or Applicant of Cited Document	Translation ⁶
		Country Code ³	Number ⁴	Kind Code ⁵ (if known)			
	2	JP	2000-164746		6/16/2000	Sumitomo Special Metals Co Ltd	Abstract
	3	JP	11-354699		12/24/1999	Furukawa Electric Co Ltd: The	Abstract
	4	JP	2003-209197		7/25/2003	Sumitomo Special Metals Co Ltd	Abstract
	5	PCT	WO02/078085	A1	3/22/2002	Sumitomo Special Metals Co., Ltd. et al.	Abstract
	6	JP	2000-106408		4/11/2000	Kyocera Corp et al.	Abstract
	7	JP	6-151618		5/31/1994	Kyocera Corp	Abstract

NON PATENT LITERATURE DOCUMENTS

Examiner Initials*	Cite No. ¹	Include name of the author (in CAPITAL LETTERS), title of the article (when appropriate), title of the item (book, magazine, journal, serial, symposium, catalog, etc.), date, page(s), volume-issue number(s), publisher, city, and/or country where published.	Translation ⁶
	8	T. YAMAMOTO et al., "Evaluation of Reactivity between Sn-Ag Solder and Au/Ni-Co Plating to...", 10 th Symposium on "Microjoining and Assembly Technology in Electronics, Feb. 5-6, 2004 pp. 117-122	
	9	International Search Report of International Application PCT/JP2005/017599 mailed November 15, 2005	

Examiner Signature	/Jonathan Han/	Date Considered	05/29/2009
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*EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.

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ALL REFERENCES CONSIDERED EXCEPT WHERE LINED THROUGH. /J.H./